

# **Embedded Systems Design**

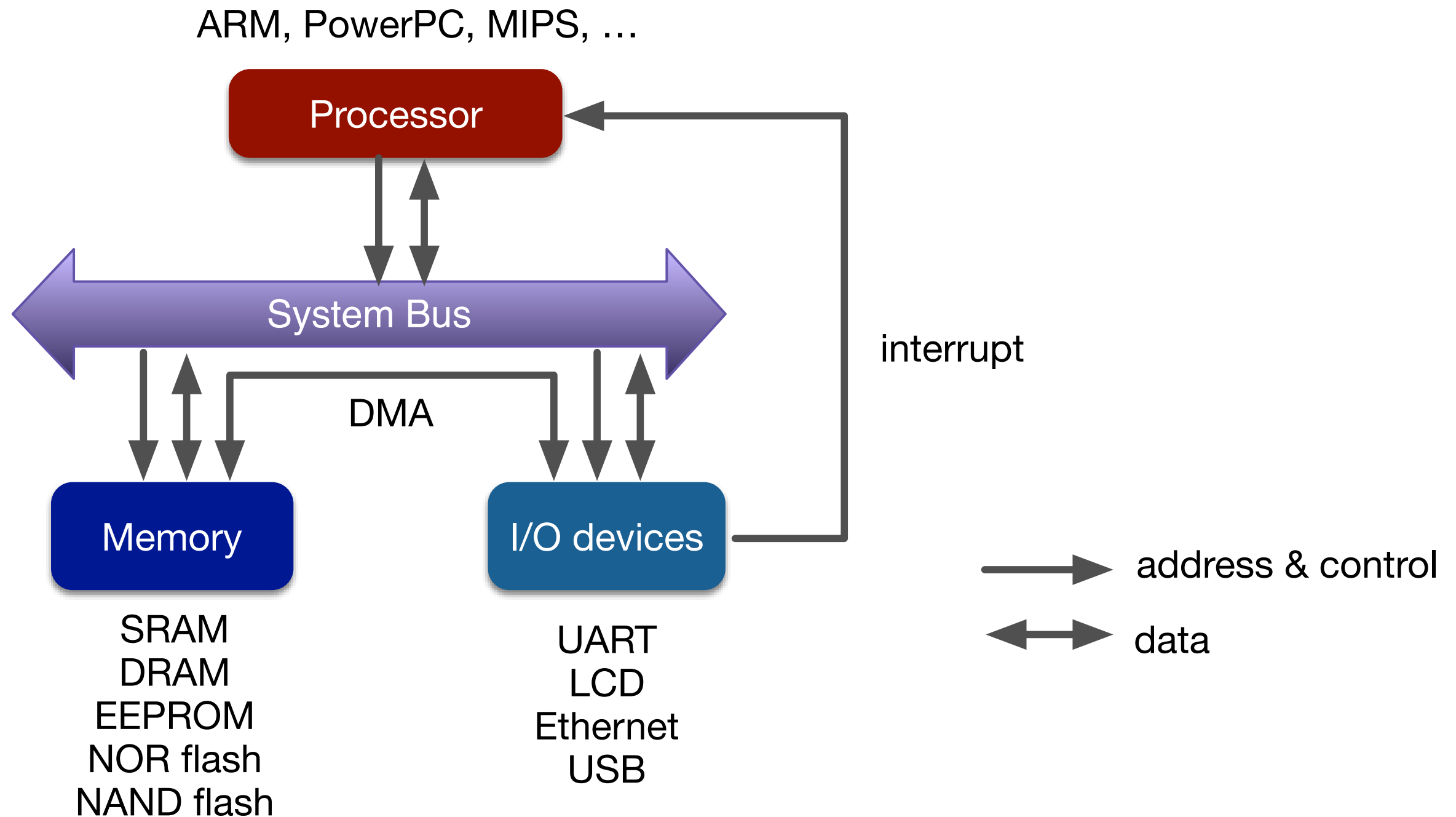
## **Lecture 4**

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# Topics

- Embedded Systems Design Workflow
- Embedded Processor Structure
- Memory Systems
- I/O Systems

# Embedded HW Structure





# Memory Systems

- Role
  - Workspace for computer programs
  - Permanent storage for programs and data

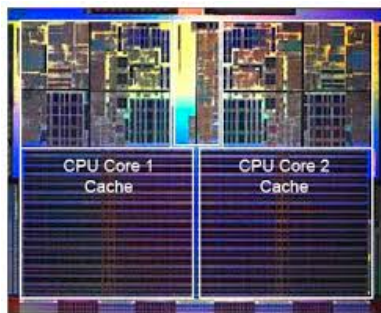


<http://www.christelow.com/images/illustrator%20desk.jpg>



# Memory Systems

- Abstraction of memory
  - Virtually flat memory space
    - A single logical address space from an application perspective
    - Assume an ideal memory: read/write any location in 1 CPU clock
- Implementation
  - Impossible to implement using a single type of memory device
  - A well-implemented “**Memory Hierarchy**”
  - Composed of a set of memory subsystems
    - Caches, DRAMs, disks, tapes, distributed file systems, etc.

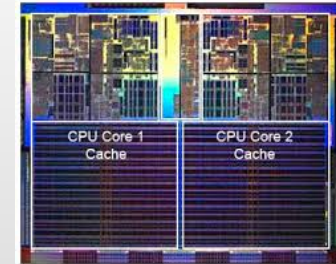




# Memory Hierarchy

- Goal: simultaneously achieve speed & capacity
  - Speed: to provide the performance of the fastest component
  - Capacity: at a cost of the cheapest component
- Locality of reference
  - The key to memory hierarchy design

Speed

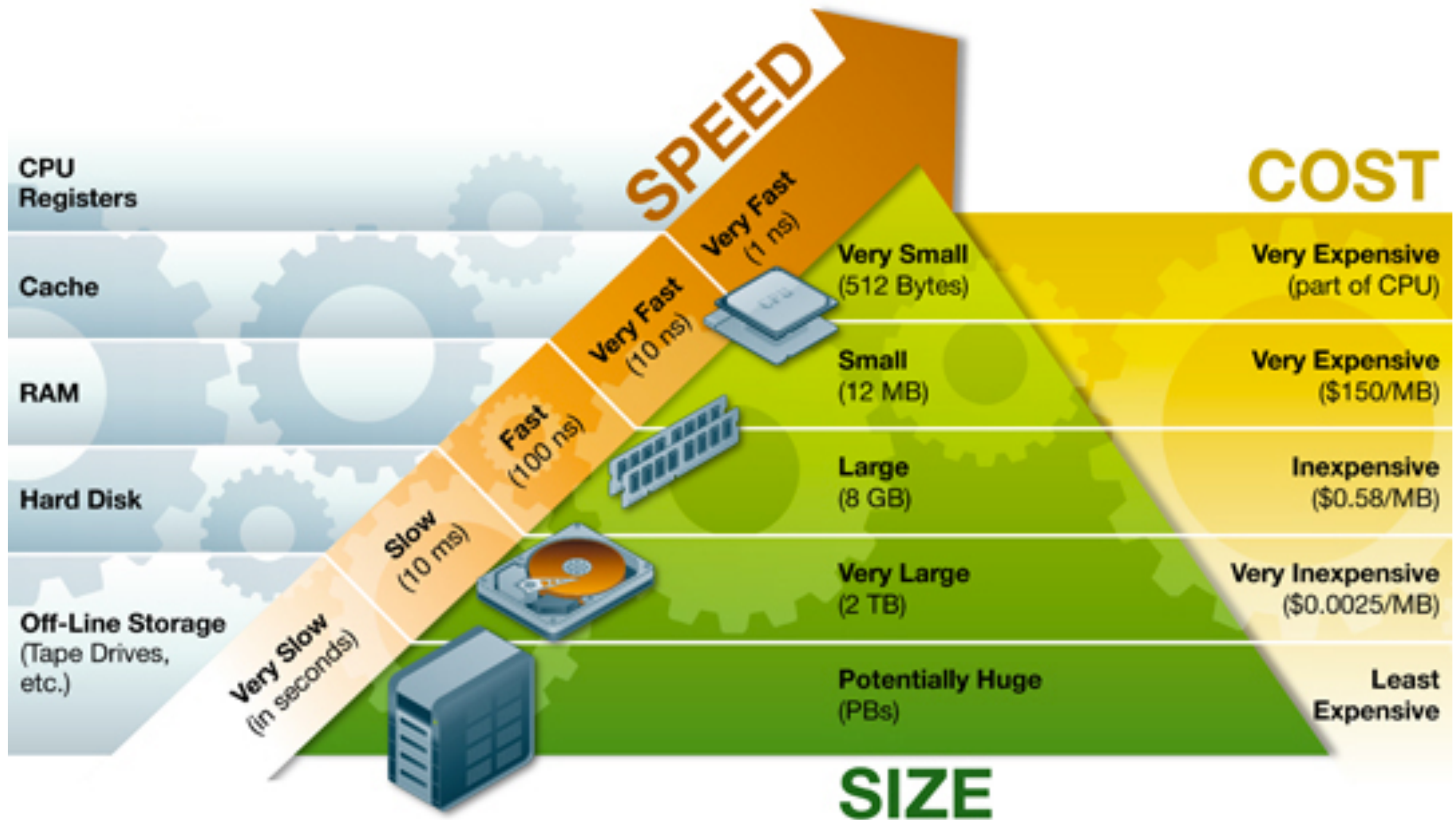


Capacity & cost

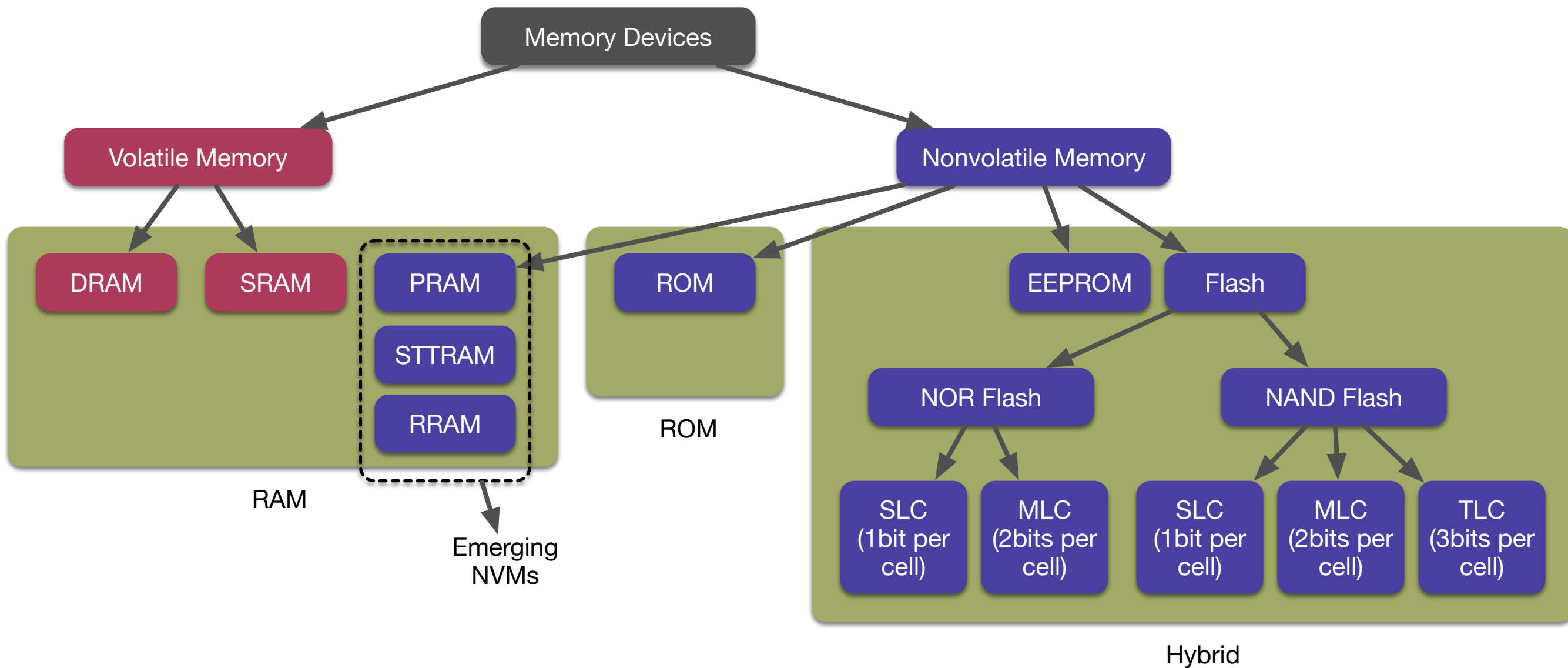


Temporal Locality	Spatial Locality
If one memory location is referenced, it will be highly likely to be referenced again in the near future.	If one memory location is referenced, its neighbor will be highly likely to be referenced in the near future.

# Memory Hierarchy



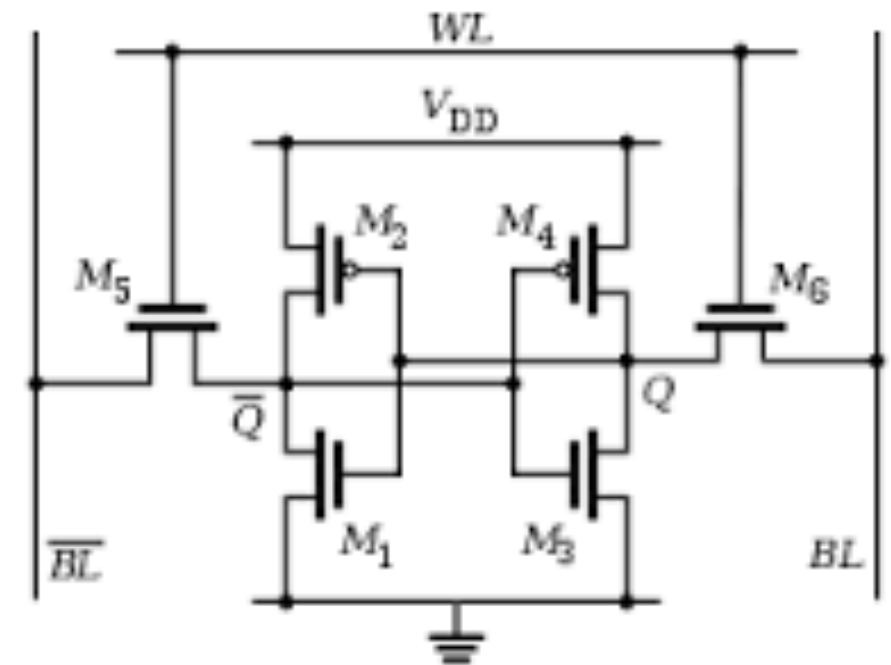
# Memory Taxonomy





# SRAM (Static RAM)

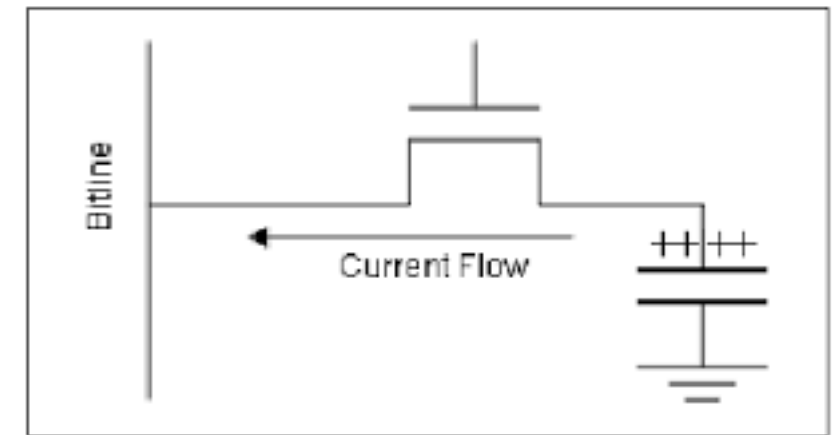
- 4T or 6T structure (T=transistor)
- Volatile
  - Data is lost when not powered
- Stable
  - Holds value as long as power applied
- Very fast (~tens of ns)
  - Suitable for L1 and L2 caches
- Very Expensive
  - Typical size range: tens of Kbits ~ several Mbits



6T SRAM cell

# DRAM (Dynamic RAM)

- 1T1C structure (C=capacitor)
  - The charge gradually leaks off
- Volatile
  - Data is lost when not powered
- Unstable
  - Data is lost without a periodic refresh
- Destructive read (charge consumed by read)
  - Must rewrite after read!
- Fast (~hundreds of ns)
  - Suitable for main memory
- Very Expensive
  - Typical size range: several Gbits



1T1C DRAM cell  
(electric charge on a small capacitor)



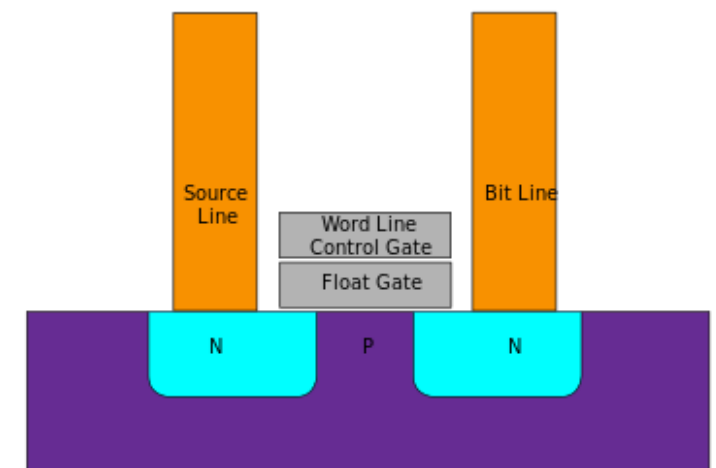
DIMM (dual in-line memory module)



charge in the capacitor = water in the glass

# Flash Memory

- Operation principle
  - Electrons trapped in the floating gate
- Nonvolatile
  - Electrons remain without power supply
  - Can be removed when high voltage supplied (erase operation)
- Read/write(program) unit
  - Page (1KB~4KB)
- Erase Unit
  - Block tens of pages (e.g., 64 pages)
- Out-place update
  - Erase-before write constraint
  - Requires garbage collection



Flash cell structure

[https://upload.wikimedia.org/wikipedia/en/thumb/2/2c/Flash\\_cell\\_structure.svg/440px-Flash\\_cell\\_structure.svg.png](https://upload.wikimedia.org/wikipedia/en/thumb/2/2c/Flash_cell_structure.svg/440px-Flash_cell_structure.svg.png)

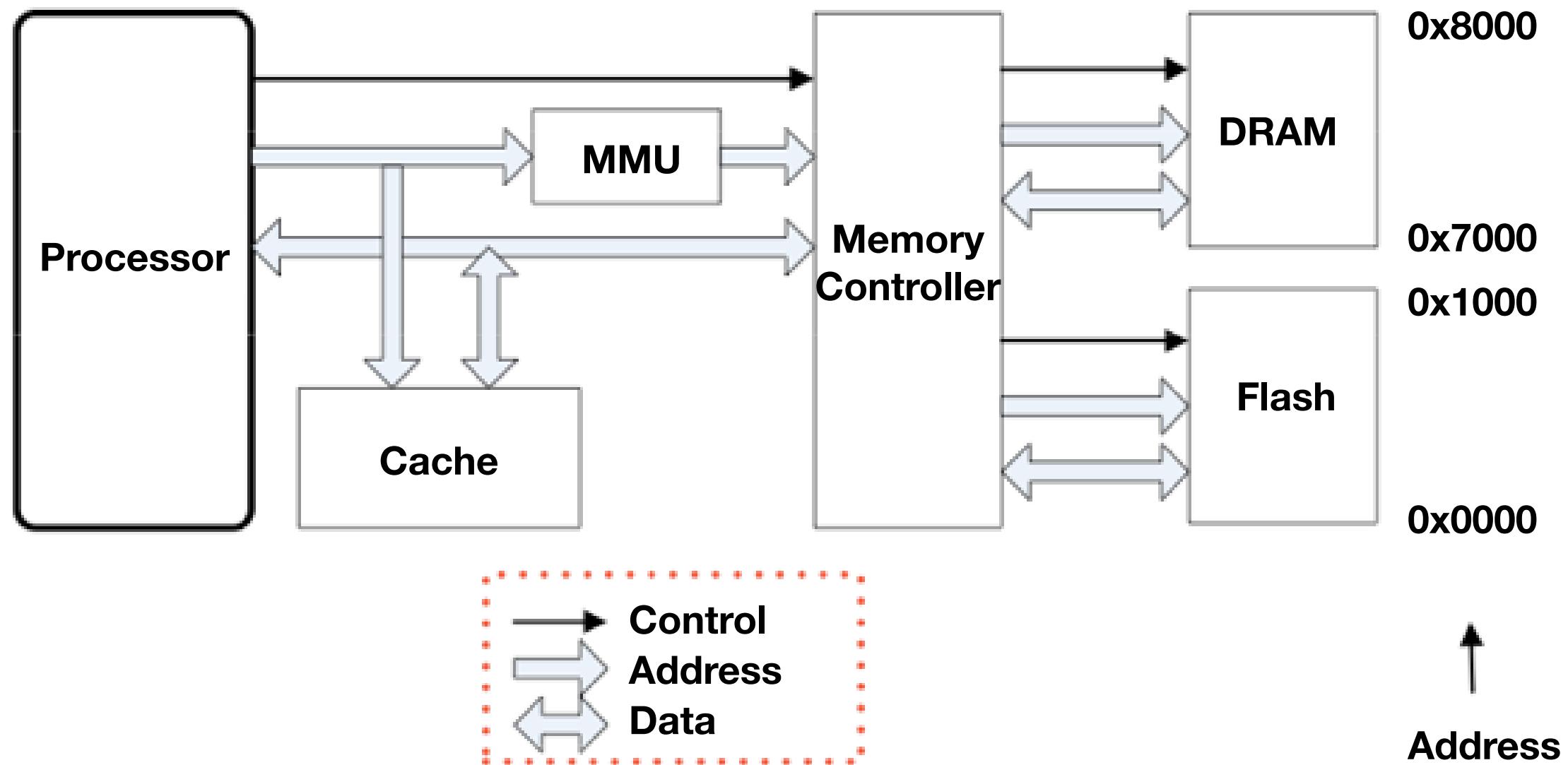


# Multi-Level Cell Flash

- Store two or more bits per cell
  - Fine-grained control of the amount of charge to be stored
- Features
  - Lower cost-per-bit
  - Slower program speed
  - Slower read speed
  - Decreased write endurance
  - Decreased data retention time

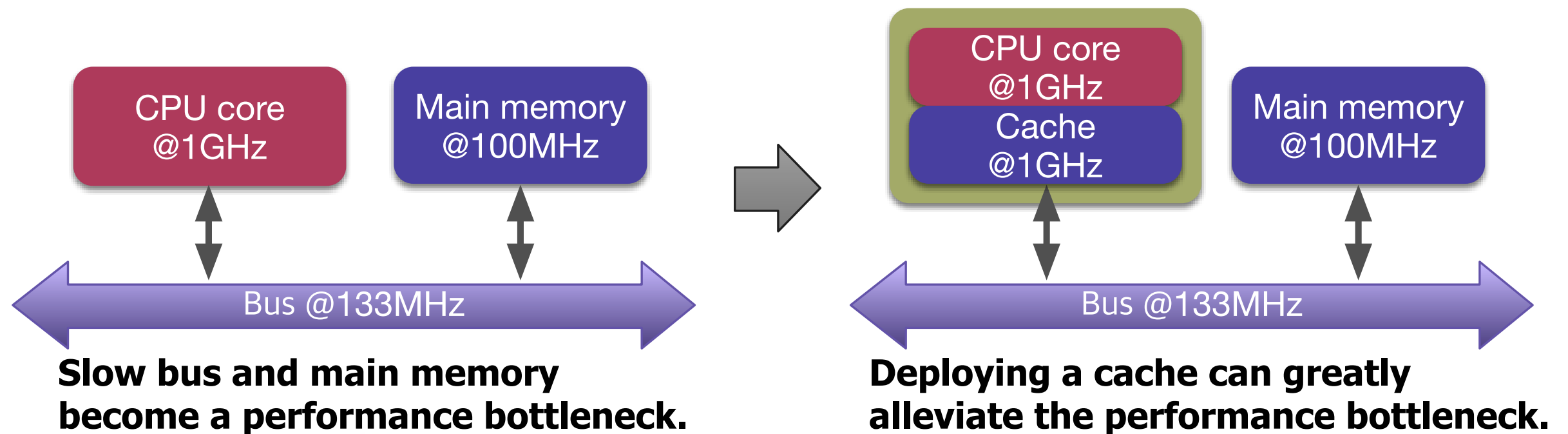


# Memory System Structure



# Cache Memory

- A small size & high speed memory
  - Stores a part of frequently used data
- Most of memory accesses hit in the cache
  - Provide lower average memory access time
  - Exploit temporal & spatial localities





# Cache Performance

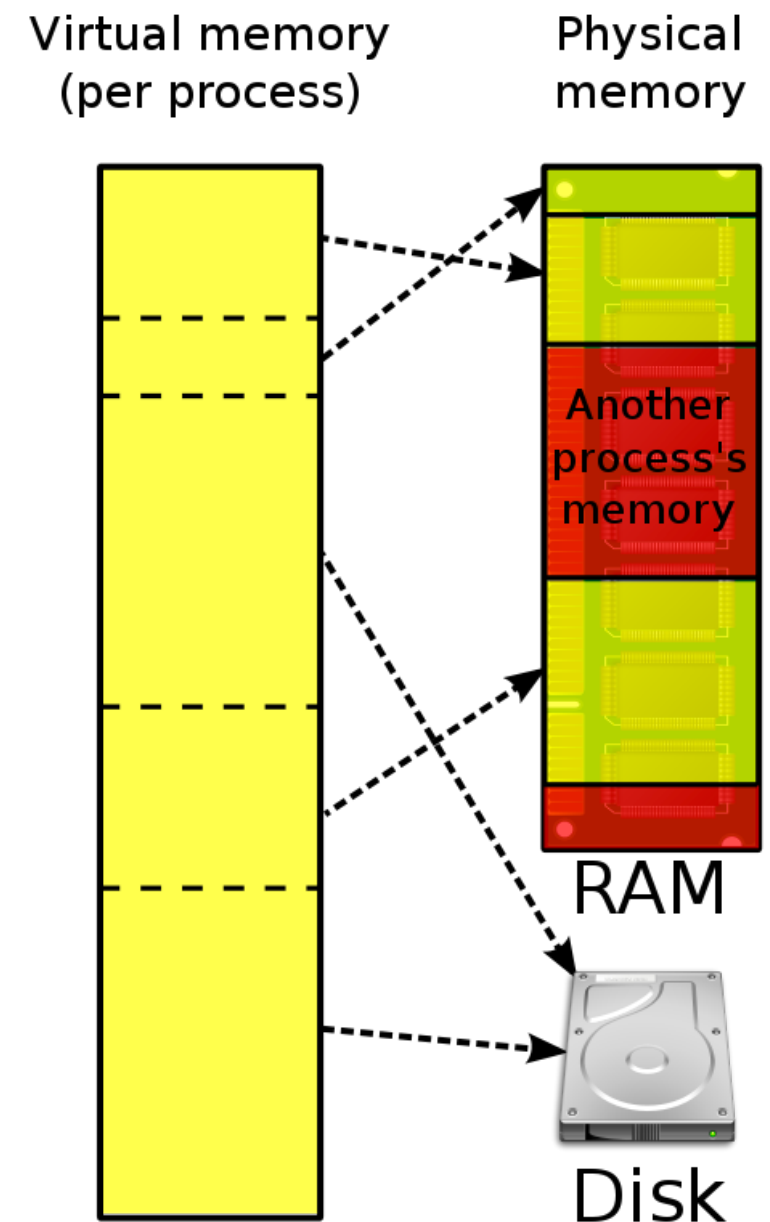
- Design goal
  - Supply instructions and data to the CPU as fast as possible
- Cache hit
  - Requested data found in the cache
  - Hit time: access latency for data in the cache
- Cache Miss
  - Requested data not found in the cache
  - Miss penalty: elapsed time to fetch the missed cache line from main memory (line fill)
- Average access time
  - Access time = (hit time) + (miss rate)x(miss penalty)

# Cache Writing Policy

Write hit		Write miss	
Write through	Write back	Write allocate	No-write allocate
<ul style="list-style-type: none"><li>• Write is done both to the cache and to the main memory.</li></ul>	<ul style="list-style-type: none"><li>• Write is done only to the cache.</li><li>• Main memory is updated when the associated cache block is evicted from the cache (lazy write)</li></ul>	<ul style="list-style-type: none"><li>• Missed cache block is first loaded to the cache, followed by a write-hit operation.</li></ul>	<ul style="list-style-type: none"><li>• Missed cache block is not loaded to the cache.</li><li>• Data is directly written to the main memory.</li></ul>

# MMU (Memory Management Unit)

- Address translation
  - Convert virtual memory addresses to physical memory addresses
- Memory protection
  - To prevent a process from accessing memory that has not been allocated to it



[https://upload.wikimedia.org/wikipedia/commons/thumb/6/6e/Virtual\\_memory.svg/500px-Virtual\\_memory.svg.png](https://upload.wikimedia.org/wikipedia/commons/thumb/6/6e/Virtual_memory.svg/500px-Virtual_memory.svg.png)



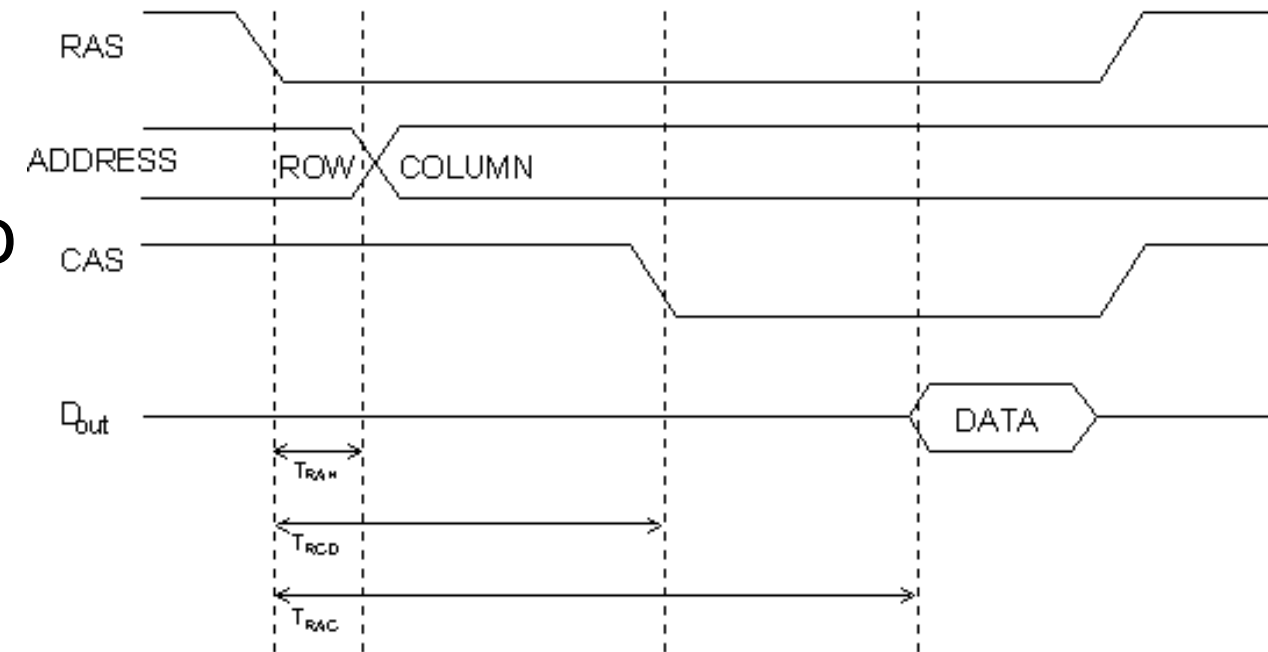
# Memory Controller

- Role

- Manage the flow of data going to and from the main memory

- Functions

- Address decode
  - Determine a target memory device
  - Assert a proper memory control signal (chip select)
- Address multiplexing (for DRAM)
  - Split a given address into row and column address
  - Same address pins used to feed both ROW and COL addresses
- Refresh operation (for DRAM)
  - Periodic read and write of every memory cells



# I/O Devices

- Similar to memory devices
  - Use of address bus, data bus, and control signals
- I/O-mapped I/O (or port-mapped I/O)
  - Dedicated address space for I/O devices
  - Ex) Intel X86
- Memory-mapped I/O
  - The same address bus for both memory and I/O devices
  - Typically used for most embedded processors
  - Caution
    - I/O memory region should be configured to be “non-cacheable”
    - I/O variables should be declared as “volatile”

# I/O Resource Management

- Polling
  - Continuously check the readiness of an I/O device in a synchronous manner
  - CPU does nothing other than waiting (busy-wait)
- Interrupt
  - Allow an I/O device to send a signal for its readiness
  - CPU can run other processes
- DMA (direct memory access)
  - Data transfer between I/O devices and memory without intervention of the CPU



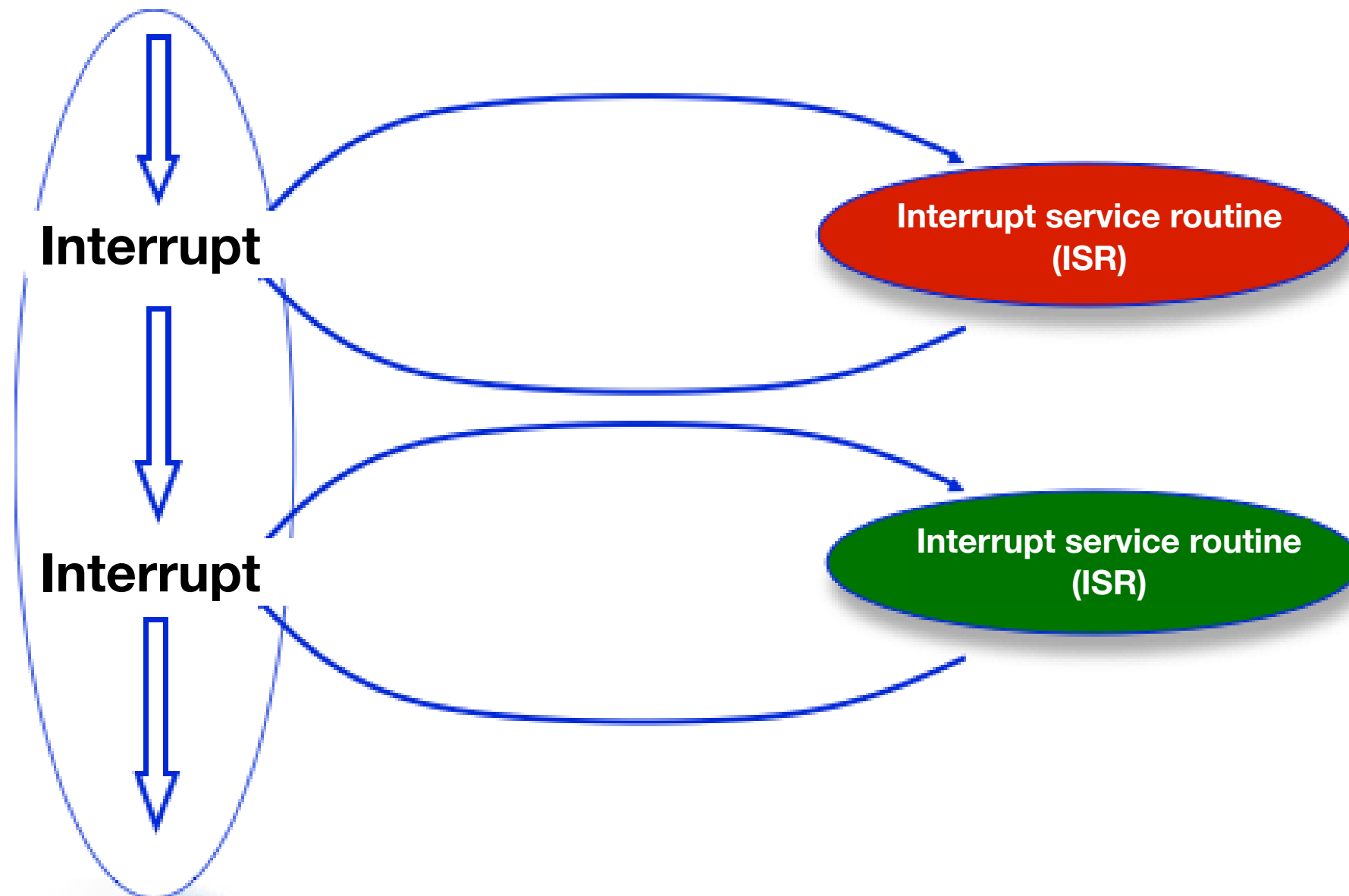
# Interrupt Interface

- Interrupt controller
  - Manage interrupt requests from I/O devices



# Interrupt Flow Control

**Main program routine**



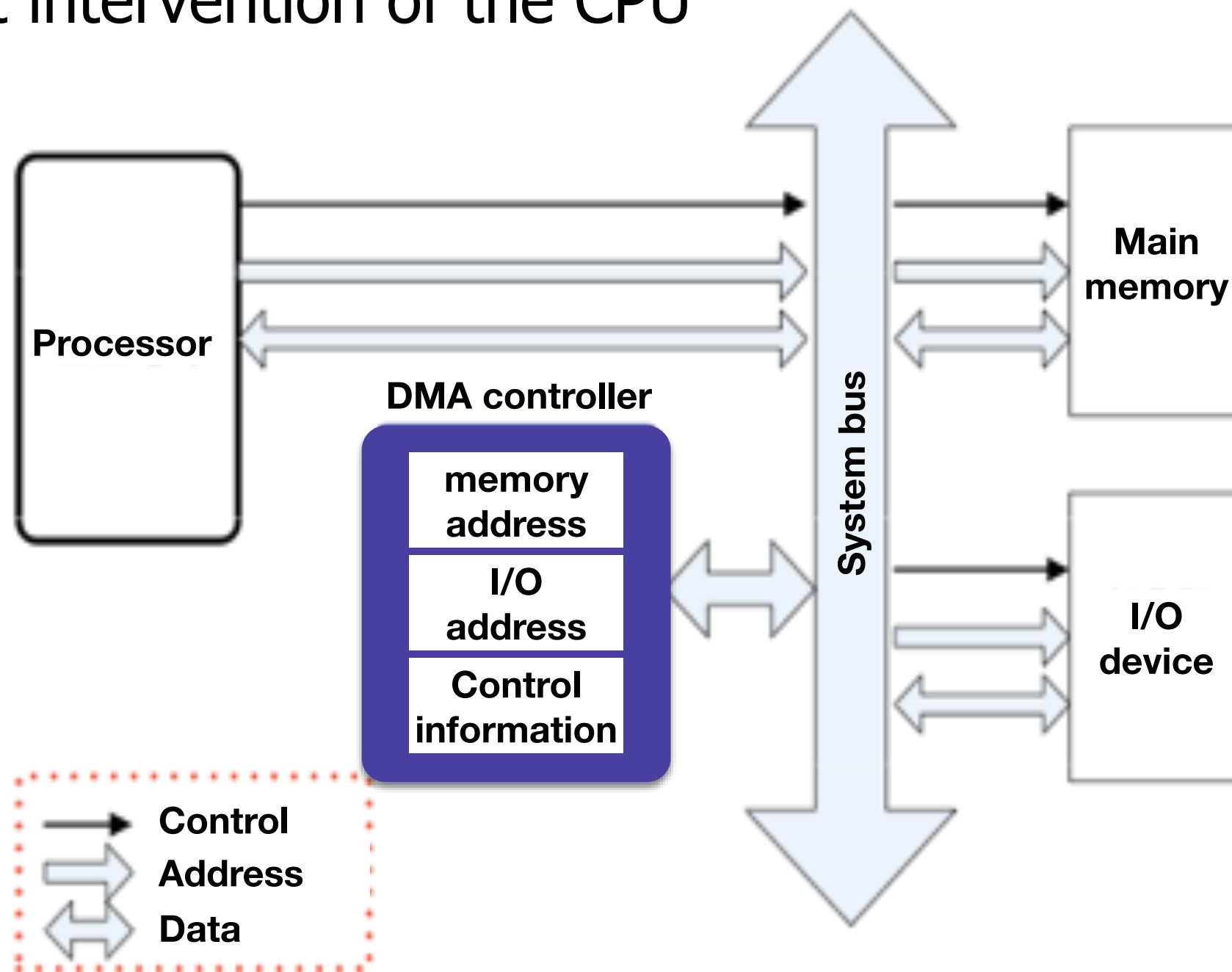
# Interrupt Vector

- Interrupt vector table
  - Memory space for storing information to associate an interrupt handler function to an interrupt request
- Fixed interrupt
  - The address for interrupt handler is fixed
- Vectored interrupt
  - The address for interrupt handler is configurable
  - Can be set by I/O devices



# DMA (Direct Memory Access)

- Data can be transferred between I/O devices and memory without intervention of the CPU



# Bus

- A set of signals shared by the components in a computer system
- Used to transfer address, data, and control information between components
- Consist of address bus, data bus, and control bus

